

Electronic Acknowledgement Receipt

| | |
|---|---|
| EFS ID: | 9308050 |
| Application Number: | 09928737 |
| International Application Number: | |
| Confirmation Number: | 7252 |
| Title of Invention: | SEMICONDUCTOR PACKAGE AND METHOD THEREFOR |
| First Named Inventor/Applicant Name: | Son Ky Quan |
| Customer Number: | 23125 |
| Filer: | James L Clingan/Dee Matocha |
| Filer Authorized By: | James L Clingan |
| Attorney Docket Number: | SC09785T CD1 |
| Receipt Date: | 26-JAN-2011 |
| Filing Date: | 13-AUG-2001 |
| Time Stamp: | 11:34:50 |
| Application Type: | Utility under 35 USC 111(a) |

Payment information:

| | |
|------------------------|----|
| Submitted with Payment | no |
|------------------------|----|

File Listing:

| Document Number | Document Description | File Name | File Size(Bytes)/ Message Digest | Multi Part /.zip | Pages (if appl.) |
|-----------------|---|--|--|------------------|------------------|
| 1 | Information Disclosure Statement (IDS) Filed (5B/08) | SC09785T-CD1-USA-20110125- Information-Disclosure- Statement.pdf | 777377 <small>3a280148b38e6c48076a3556ab6a5324801137a</small> | no | 4 |

Warnings:

Information:

| | | | | | |
|---|---------------|---|--|----|-----|
| 2 | NPL Documents | Nguyen-Leadframe-Designs-for-Minimum-Molding-Induced-Warpage.pdf | 706176 8b2c3e4e00122eae2802d87ac7cb60a0f4425 | no | 8 |
| Warnings: | | | | | |
| Information: | | | | | |
| 3 | NPL Documents | JEDEC-MO-151-Nov-1993-S-PXGA-XPBGA-Plastic-Ball-Grid-Array-Family-Registration.pdf | 450961 95a0892ba51116a5a6d4e1108ba3e0ce7a2fda938 | no | 7 |
| Warnings: | | | | | |
| Information: | | | | | |
| 4 | NPL Documents | REDACTED-2011-01-06-Order-No-34-ID-Granting-Respondent-MSD-of-Non-Infringement-of-the-306-CBI.pdf | 2969321 4230004504596c9ba087d1ade3bd3c56c38e067 | no | 54 |
| Warnings: | | | | | |
| Information: | | | | | |
| 5 | NPL Documents | FSI-Petition-20110114-re-Order-34-on-Non-Infringement-of-the-306-Patent.pdf | 5738437 0a02140b1d4a90bc200b1ae010d0715ac0d374008 | no | 134 |
| Warnings: | | | | | |
| Information: | | | | | |
| Total Files Size (in bytes): | | | 10642272 | | |
| This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503. | | | | | |
| New Applications Under 35 U.S.C. 111 | | | | | |
| If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application. | | | | | |
| National Stage of an International Application under 35 U.S.C. 371 | | | | | |
| If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course. | | | | | |
| New International Application Filed with the USPTO as a Receiving Office | | | | | |
| If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application. | | | | | |